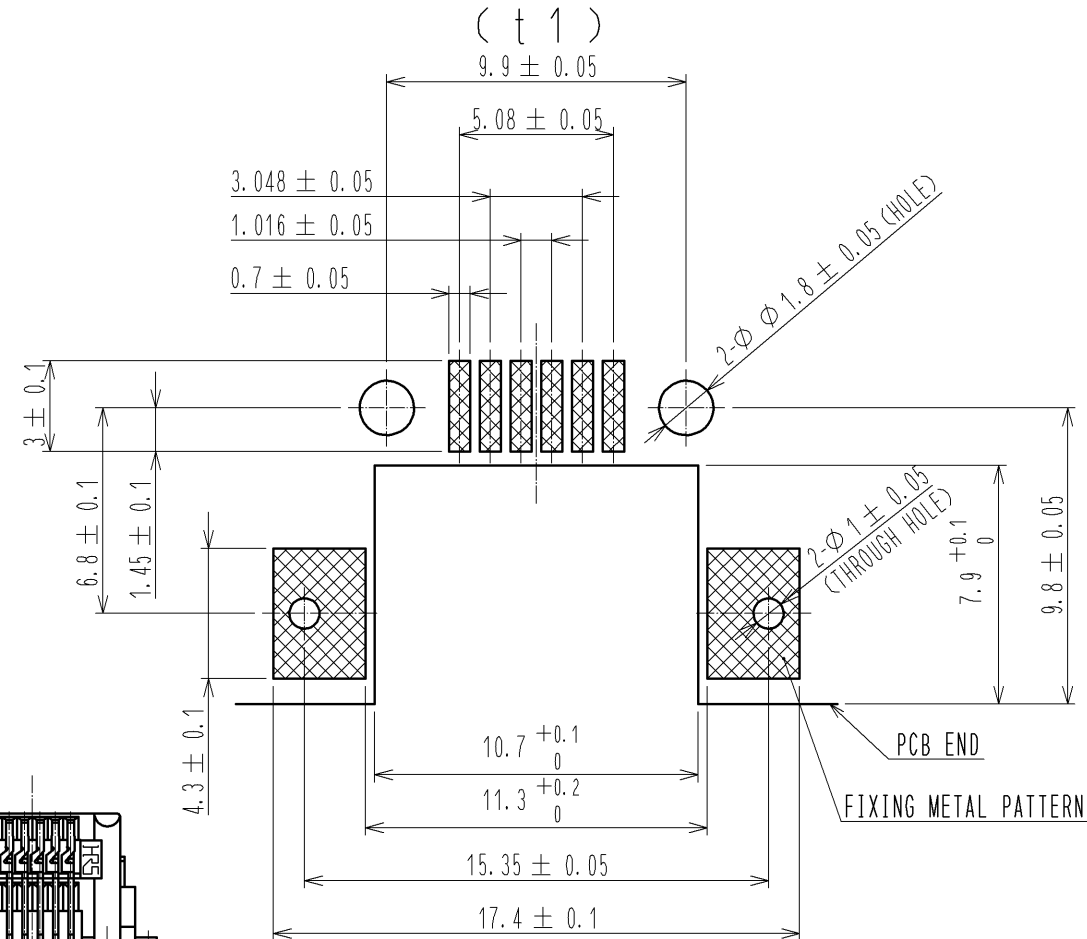
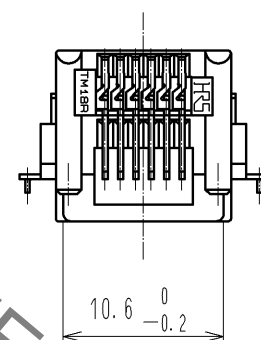
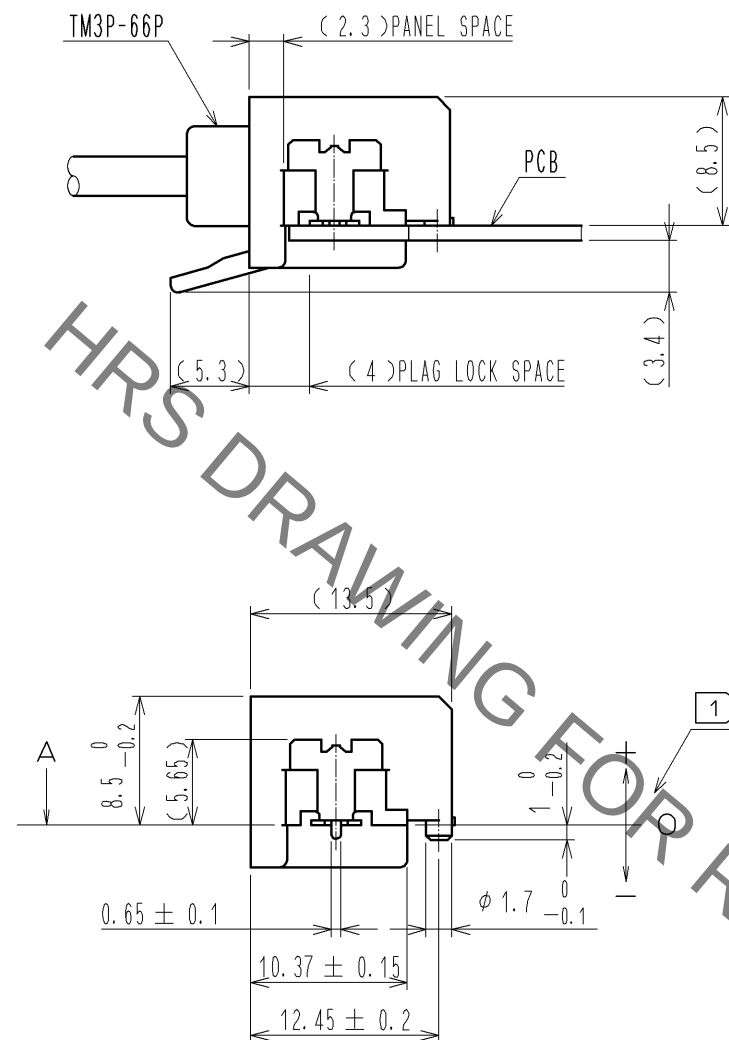
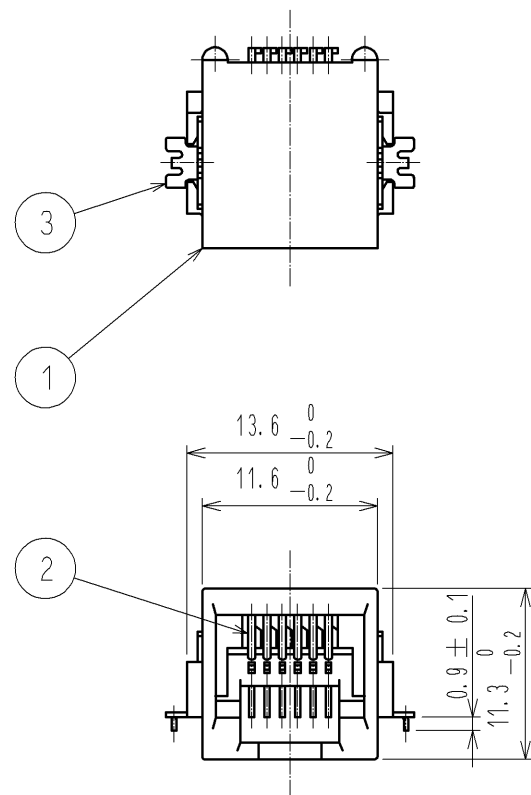
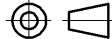


MATED

RECOMMENDED PC BOARD PATTERN (4:1)



NOTE 1 SOLDERED FACES ON THE CONTACTS AND METAL FITTINGS SHALL BE POSITIONED WITHIN 0+0.05/-0.1 FROM THE SURFACE A

2	PHOSPHOR BRONZE	CONTACT: GOLD PLATING 1.27μm MIN LEAD : TIN PLATING 2μm MIN UNDER :NICKEL PLATING 1μm MIN		3	BRASS	ONER : TIN PLATING 2μm MIN UNDER:NICKEL PLATING 1μm MIN			
1	PPS	BLACK, UL94V-0							
NO.	MATERIAL	FINISH , REMARKS		NO.	MATERIAL	FINISH , REMARKS			
UNITS mm		SCALE 2 : 1		COUNT	DESCRIPTION OF REVISIONS		DESIGNED	CHECKED	DATE
 HIROSE ELECTRIC CO., LTD.		APPROVED :YH. ENAMI		10.11.26	DRAWING NO.		EDC3-124562-01		
		CHECKED :YH. ENAMI		10.11.26	PART NO.		TM18R-66(50)		
		DESIGNED :MT. ITANO		10.11.26	CODE NO.		CL222-2930-7-50		
		DRAWN :MT. ITANO		10.11.26			 1/1		